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SHARP

ELECTRONIC COMPONENTS GROUP
SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFICATION FOR

Light Emitting Diode

MODEL No.

GL5ZR44

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2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas;
 - * OA equipment * Audio visual equipment * Home appliance
 - * Telecommunication equipment (Terminal) * Measuring equipment
 - * Tooling machines * Computers
 If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.
- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as ;
 - * Transportation control and safety equipment (aircraft, train, automobile etc.)
 - * Traffic signals * Gas leakage sensor breakers * Rescue and security equipment
 - * Other safety equipment
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;
 - * Space equipment * Telecommunication equipment (for trunk lines)
 - * Nuclear power control equipment * Medical equipment
- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.

3. Please contact and consult with a Sharp sales representative for any questions about this product.

CUSTOMER'S APPROVAL

DATE: *Jun/18/1999*
PRESENTED BY: *M.Katoh*

M.Katoh,
Department General Manager of
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SHARP CORPORATION

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GL5ZR44 Specification

1. Application

This specification applies to the light emitting diode device Model No. GL5ZR44.
[AlGaInP (dicing or scribe/break type) Red LED device]

2. Outline dimensions and pin connections Refer to the attached sheet Page 2.

3. Ratings and characteristics Refer to the attached sheet Page 3~4.

- 3-1. Absolute maximum ratings
- 3-2. Electro-optical characteristics
- 3-3. Derating Curve
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- 5-3. Test items, judgement criteria and classifica of defect
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- 6-1. Packing
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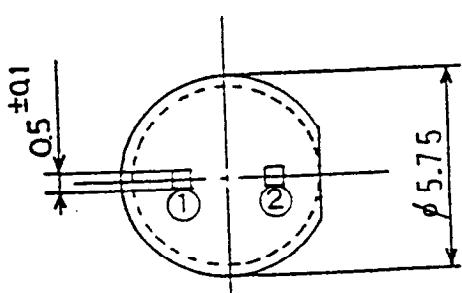
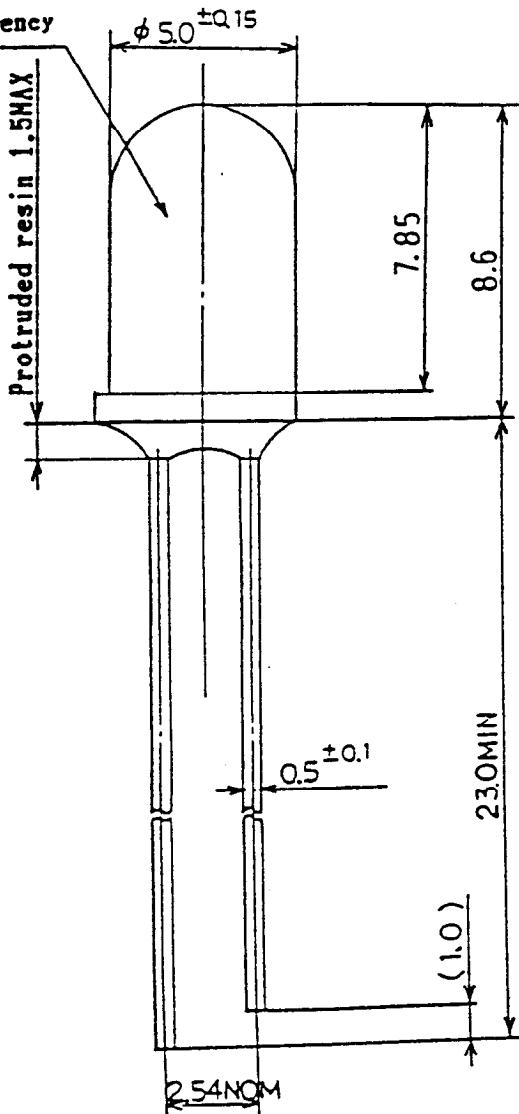
- 7-1. Lead forming method
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- 7-3. Soldering Conditions
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2. Outline dimensions and pin connections

Colorless transparency



Pin connections
 ①. Anode
 ②. Cathode

(Note) Unspecified tol. to be $\pm 0.2\text{mm}$

(Note) Cold rolled steel leads are plated with but the tie-bar cut portions have no plating do not solder this part of the product.

Unit	Material	Finish	Drawing No.
mm	Lead : (Fe) Cold rolled steel Package : Epoxy resin	Lead : Sn plated or wave soldering	5 1 1 0 6 0 2 4

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3. Ratings and characteristics

3-1. Absolute maximum ratings

(Ta=25°C)			
Parameter	Symbol	Value	Unit
Power dissipation	P	130	mW
Continuous forward current	I _F	50	mA
Peak forward current(Note 1)	I _{FM}	100	mA
Derating factor DC	-	0.67	mA/°C
	Pulse	1.33	mA/°C
Reverse voltage	V _R	5	V
Operating temperature	T _{opr}	-40 ~ 85	°C
Storage temperature	T _{stg}	-40 ~ 100	°C
Soldering temperature(Note 2)	T _{sol}	260 (within 5 seconds)	°C

(Note 1) Duty ratio=1/10, Pulse width=0.1ms

(Note 2) At the position of 1.6mm from the bottom resin package

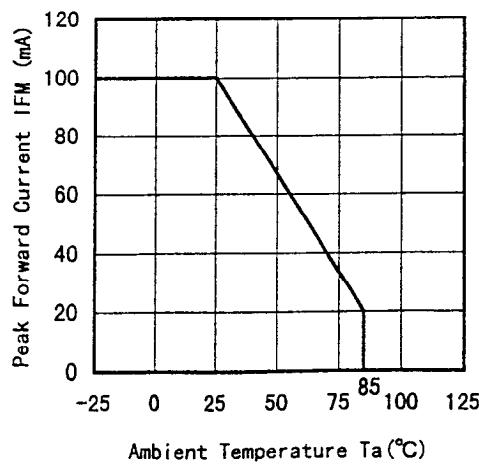
3-2. Electro-optical characteristics

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward voltage	V _F	IF=20mA	—	2.1	2.6	V
Luminous intensity (Note 3)	I _v		552	1700	—	mcd
Peak emission wavelength	λ _p		—	647	—	nm
Dominant wavelength	λ _d		—	635	—	nm
Spectrum radiation bandwidth	△λ		—	20	—	nm
Reverse current	I _R	VR=4V	—	—	100	μA
Terminal capacitance	C _t	V=0V, f=1MHz	—	60	—	pF
Viewing Angle	2θ _{1/2}	IF=20mA	—	15	—	deg.

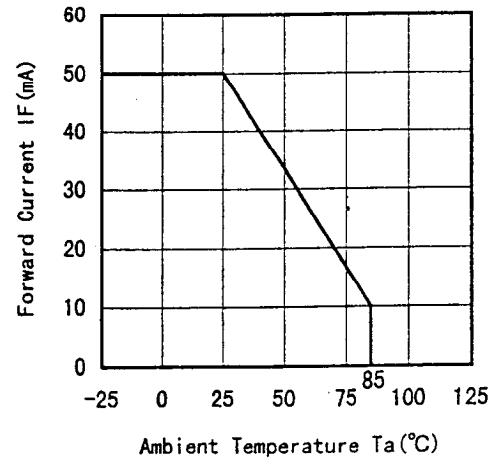
(Note 3) Refer to the supplement item 6. regarding the standard of rank classification.

3-3. Derating Curve

Peak Forward Current Derating Curve

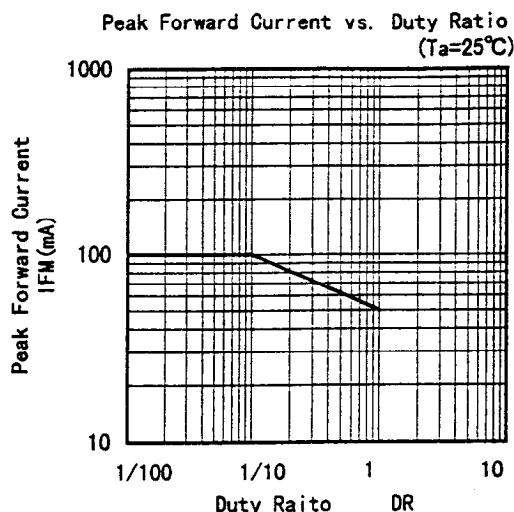


Forward Current Derating Curve

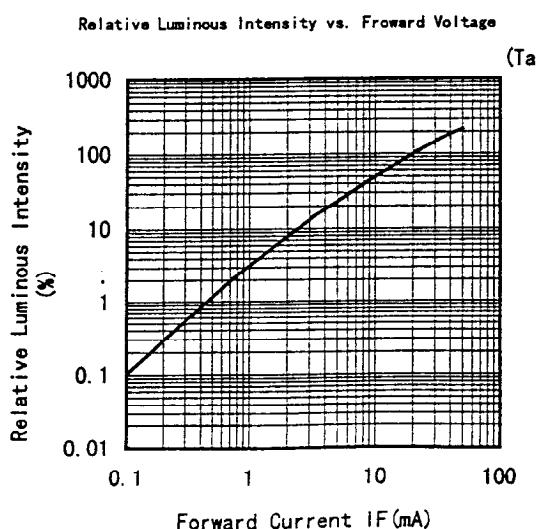
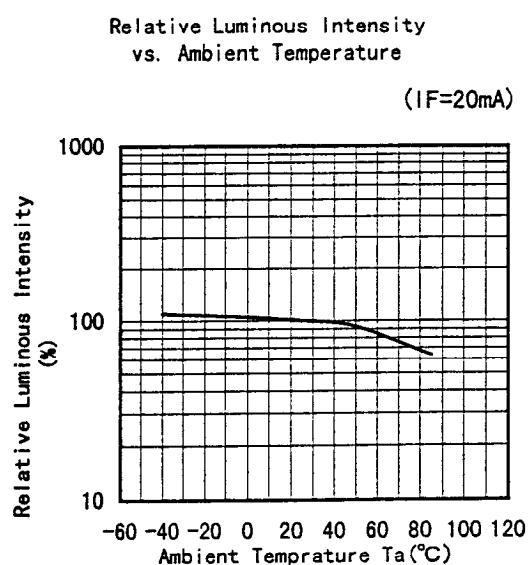
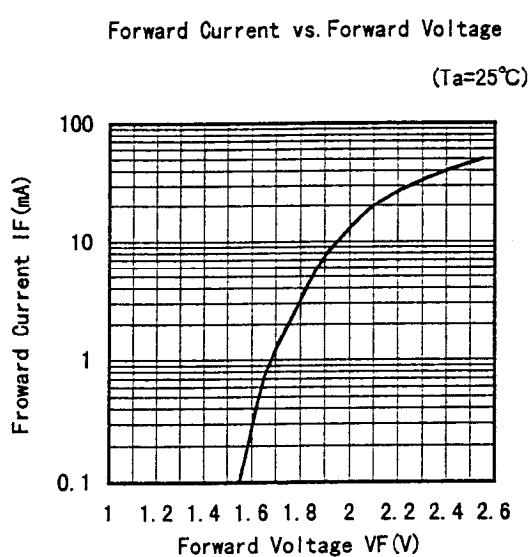


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3-4. Characteristics Diagram(typ) (Note 1)



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4. Reliability

The reliability of products shall be satisfied with items listed below.

4-1. Test items and test conditions

Confidence level: 90%

Test items	Test conditions	Samples (n) Defective (C)	LTPD (%)
Solderability	230±5°C, 5s Prior disposition : Dip in rosin flux	n=11, C=0	20
Soldering temperature	260±5°C, 5s	n=11, C=0	20
Mechanical shock	15 000m/s ² , 0.5ms, 3times / ±X,±Y,±Z direction	n=11, C=0	20
Variable frequency vibration	200m/s ² , 100 to 2 000 to 100Hz/sweep for 4min. ,4times/±X,±Y,±Z direction	n=11, C=0	20
Terminal strength (Tension)	Weight:10N, 5s/ each terminal	n=11, C=0	20
Terminal strength (Bending)	Weight:5N, 0° → 90° → 0°→ -90° → 0° /each terminal	n=11, C=0	20
Temperature cycling	-40°C(30min)～+100°C(30min),30 cycles	n=22, C=0	10
High temp. and high humidity storage	Ta=+60°C, 90%RH, t=1000h	n=22, C=0	10
High temperature storage	Ta=100°C, t=1000h	n=22, C=0	10
Low temperature storage	Ta=-40°C, t=1000h	n=22, C=0	10
Operation life	Ta=25°C, I _F MAX, t=1000h *3	n=22, C=0	10

4-2. Measurement items and Failure judgement criteria *1

Measurement	Symbol	Failure judgement criteria *2
Forward voltage	V _F	V _F > U.S.L. × 1.2
Reverse current	I _R	I _R > U.S.L. × 2.0
Luminous intensity	I _V	I _V > The first stage value × 2.0 or The first stage value × 0.5 > I _V

*2: Solderability : Solder shall be adhere at the area of 95% or more of dipped portion.

*3: Terminal strength : Package is not destroyed, and terminal is not slack.

*1: Measuring condition is in accordance with specification.

*2: U.S.L. is shown by Upper Specification Limit.

*3: I_F MAX is shown by forward current of absolute maximum ratings.

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5. Incoming inspection

5-1. Applied standard : ISO 2859-1

5-2. Sampling method and level : A single sampling plan,normal inspection level II

: AQL Major defect : 0.065%

Minor defect : 0.4%

5-3. Test items, judgement criteria and classifica of defect

No.	Test items	judgement criteria	classifica of defect
1	Disconnection	Not emit light	
2	Position of Cutting off rim	Different from dimension	Major defect
3	Reverse terminal	Different from dimension	
4	Outline dimensions	Not satisfy outline specification	
5	Characteristics	Over the limit value of specification at V_F , I_R , and I_V	
6	Cut off the rim	Exceed -0.2mm	
7	Foreign substance	White point : Exceed ϕ 0.3mm (on top view) Black point : Exceed ϕ 0.3mm (on top view) String form : Exceed 3.0mm (on top view)	
8	Scratch	Exceed ϕ 0.3mm or 0.1mm \times 1.0mm (on top view)	Minor defect
9	Void	Exceed ϕ 0.3mm (on top view)	
10	Uneven density of material for scattering	Extremely uneven density	
11	Unbalanced center	Exceed \pm 0.25mm from package center	
12	Burr	Exceed +0.2mm against provided dimension	
13	Insertion position of terminal	Insertion position of terminal	

5-4. Test items the surface is be applied for flat type, judgement criteria and classifica of defect

No.	Test items	judgement criteria	classifica of defect
14	Chapped the surface	The surface chapped is striking for see the lamp top	Minor defect
15	Hollow the surface	The surface hollow is striking for see the lamp top	

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6. Supplement

6-1. Packing

6-1-1. Inner package

Put 250pcs the same luminous intensity rank products into pack and put following label by pack.

Product weight : 0.28g (One Product,Typ.)

(Indication label sample)

SHIPMENT TABLE							
PART No.	GL5ZR44	← Model number					
QUANTITY	250	← Quantity of products	* <input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
LOT No.	KA99B19	← Lot number *	(1)	(2)	(3)	(4)	(5)
		□-□ ← Luminous intensity rank					
		S H A R P ← dominant wavelength rank					
		MADE IN JAPAN ← Production country					

(1) Production plant code(to be indicated alphabetically)

(2) Support code

(3) Year of production(the last two figures of the year)

(4) Month of production (to be indicated alphabetically with January corresponding to A)

(5) Date of production(01~31)

6-1-2. Outer package

Put 8 packs (the same luminous intensity rank) into outer package.

(approximately 670g per one outer package)

6-1-3. Outer package out line dimension

Width : 140mm, Depth : 225mm, Hight : 90mm

6-2.Luminous intensity rank (Note 1) (Ta=25°C)

Rank	Luminous intensity		Unit	Condition
L	552	~	1075	mcd I _F =20mA
M	795	~	1548	
N	1144	~	2229	
O	1648	~	(3210)	

(Note 1) Tolerance:±15%

In regard to luminous intensity , the following ranking shall be carried out.

However the quantity of each rank shall not be pre scribed.

In case of the distribution of the luminous intensity shift to high, at that point new upper rank is prescribed and lower rank is delete.

6-3.Dominant wavelength rank (Note 2) (Ta=25°C)

Rank	Dominant wavelength		Unit	Condition
Y	628.5	~	632.5	nm I _F =20mA
Z	631.5	~	635.5	
1	634.5	~	638.5	
2	637.5	~	641.5	
3	640.5	~	644.5	

(Note 2) The condition of measurement : The measurement of the light emission from the front side of lamp.

This rank value is the setting value of when that classifies it the rank and be not a guarantee value.

Also I shall not ask the delivery ratio of each rank.

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6-4. Environment

6-4-1. Ozonosphere destructive chemicals.

- (1) The device doesn't contain following substance.
- (2) The device doesn't have a production line whose process requires following substance.
Restricted part: CFCs,halones,CCl₄,Trichloroethane(Methychloroform)

6-4-2. Bromic non-burning materials

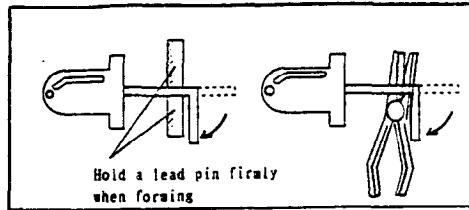
The device doesn't contain bromic non-burning materials(PBBOs,PBBs)

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7. Precautions for use

7-1. Lead forming method

Avoid forming a lead pin with the lead pin base as a fulcrum: be sure to hold a lead pin firmly when forming. Lead pins should be formed before soldering.



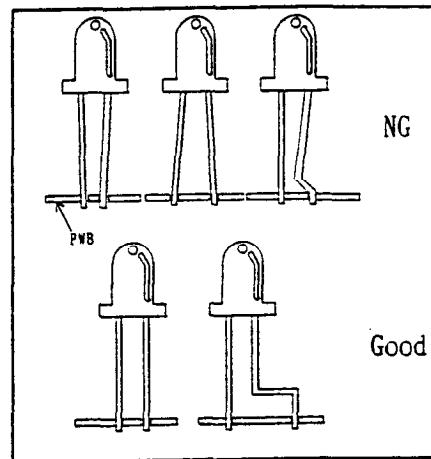
7-2. Notice of installation

7-2-1 installation on a PWB

When mounting an LED lamp on a PWB, do not apply physical stress to the lead pins.

- The lead pin pitch should match the PWB pin-hole pitch: absolutely avoid widening or narrowing the lead pins.
- When positioning an LED lamp, basically employ an LED with tie-bar cut or use a spacer.

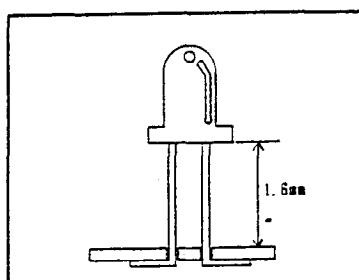
7-2-2 When an LED 1 is mounted directly on a PWB
If the bottom face of an LED lamp is mounted directly on single-sided PWB, the base of the lead pins may be subjected to physical stress due to PWB warp, cutting or clinching of lead pins. Prior to use, be sure to check that no disconnection inside of the resin or damage to resin etc., is found. When an LED lamp is mounted on a double-sided PWB, the heat during soldering affects the resin; therefore, keep the LED lamp more than 1.6mm afloat above the PWB.



7-2-3 Installation using a holder

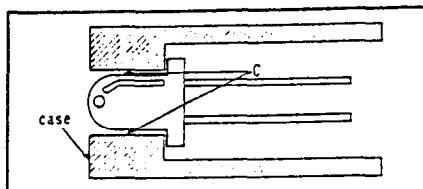
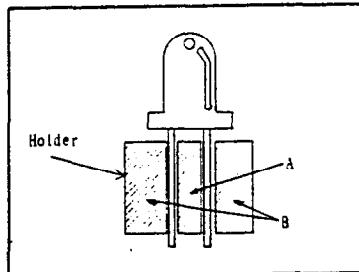
During an LED lamp positioning, when a holder is used, a holder should be designed not to subject lead pins to any undue stress.

(Note) Pay attention to the thermal expansion coefficient of the material used for the holder. Since the holder expands and contracts due to preheat and soldering heat, mechanical stress may be applied to the lead pins, resulting in disconnection.



7-2-4 Installation to the case

Do not fix part C with adhesives when fixed to the case as shown in Figure. A hole of the case should be designed not to subject the inside of resin to any undue stress.



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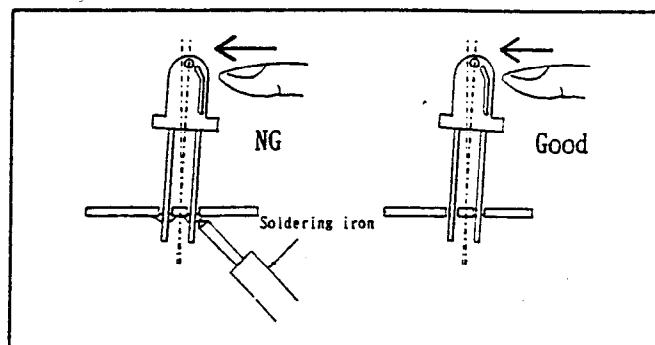
7 - 3. Soldering Conditions

Solder the lead pins under the following conditions

Type of Soldering	Conditions
1. Manual soldering	295°C ± 5°C, within 3 seconds
2. Wave soldering	260°C ± 5°C, within 5 seconds
3. Auto soldering	Preheating 70°C to 80°C, within 30 seconds Soldering 245°C ± 5°C, within 5 seconds

(Note) Avoid dipping resin into soldering bath.

Avoid applying stress to lead pins while they are heated. For example, when the LED lamp is moved with the heat applied to the lead pins during manual soldering or solder repair, disconnection may occur.



7 - 4. For cleaning

- (1) Solvent cleaning : Solvent temperature 45°C or less
Immersion for 3 min or less
- (2) Ultrasonic cleaning : The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PWB size or device mounting condition etc. Please test it in actual using condition and confirm that doesn't occur any defect before starting the ultrasonic cleaning.
- (3) Applicable solvent : Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

In case when the other solvent is used, there are cases that the packaging resin is eroded. Please use the other solvent after thorough confirmation is performed in actual using condition.